505167840 10/31/2018

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KENG-PING LIN	10/22/2018
TZU-MING OU YANG	10/22/2018
SHU-MING LI	10/22/2018
TETSUHARU KUROKAWA	10/22/2018

RECEIVING PARTY DATA

Name:	WINBOND ELECTRONICS CORP.	
Street Address:	NO. 8 KEYA 1ST RD., DAYA DISTRICT, CENTRAL TAIWAN SCIENCE PARK,	
City:	TAICHUNG CITY	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16168847	

CORRESPONDENCE DATA

Fax Number: (949)391-4699

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 886223692800

Email: USA@JCIPGroup.com

Correspondent Name: JCIPRNET

Address Line 1: P.O. BOX 600 TAIPEI GUTING
Address Line 4: TAIPEI CITY, TAIWAN 10099

ATTORNEY DOCKET NUMBER:	71509-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	10/31/2018

Total Attachments: 3

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PATENT 505167840 REEL: 047362 FRAME: 0777

DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION Declaration Submitted With Initial Filing OR Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required) (Title of the Invention) SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD **THEREOF** As a below named inventor (hereinafter designated as the undersigned), I hereby declare that: This declaration is directed to: The attached application, OR United States Application Number or PCT International application number ____Filed on _____

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

PATENT REEL: 047362 FRAME: 0778 **DECLARATION AND ASSIGNMENT**

FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements

described in the application identified.

WHEREAS, 1. Winbond Electronics Corp.

of No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park,

Taichung City, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said

invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable

consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have

sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said

Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and

to the said invention and application and all future

improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in

the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and

exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and

transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or

of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation

or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at

Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications,

execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent

and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such

other acts as Assignee Lawfully may request, to obtain

or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee,

or Assignee's successors and assigns.

PATENT REEL: 047362 FRAME: 0779

DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

Signature: Keng - Ping Lin	Date:	OCT 2 2 2018				
Legal Name of Sole or First Inventor: Keng-Ping Lin						
Residence: Taichung City, Taiwan						
Mailing Address: c/o No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park, Taichung City, Taiwan, R.O.C.						
Signature: Tzsu-Ming Du Yang	Date: _	OCT 2 2 2018				
Legal Name of Additional Joint Inventor, if any Tzu-Ming Ou Yang						
Residence: Taichung City, Taiwan						
Mailing Address: c/o No. 8 Keya 1st Rd., Daya District, C Taiwan, R.O.C.	entral Taiwa	an Science Park, Taichung City,				
Signature:Min() [i	Date: _	OCT 2 2 2018				
Legal Name of Additional Joint Prventor, if any: Shu-Ming Li						
Residence: Taichung City, Taiwan						
Mailing Address: c/o No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park, Taichung City, Taiwan, R.O.C.						
Signature: Johnhun Kunspenso	Date: _	OCT 2 2 2018				
Legal Name of Additional Joint Inventor, if any: Tetsuharu Kurokawa						
Residence: Taichung City, Taiwan						
Mailing Address: c/o No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park, Taichung City, Taiwan, R.O.C.						